REMARKS

Favorable reconsideration of this application is respectfully requested.

Claims 65-91 are pending in this application. Claims 65-91 were rejected under 35 U.S.C. § 112, first paragraph. Claims 65-66, 73-74, 80-81, and 87 were rejected under 35 U.S.C. § 103(a) as unpatentable over U.S. patent application publication 2001/0014836 A1 to Tamaki et al. (herein "Tamaki"). Claims 67-72, 75-79, 82-86, and 88-91 were rejected under 35 U.S.C. § 103(a) as unpatentable over Tamaki in view of U.S. patent 5,539,652 to Tegethoff.

Addressing now the rejection of claims 65-91 under 35 U.S.C. § 112, first paragraph, that rejection is traversed by the present response.

The claims were rejected as the reference to "for a plurality of assemblies" did not appear to have support in the specification. Applicants traverse that position.

First, applicants note, for example, at page 11, line 25 to page 12, line 6 and page 13, lines 1-11 the specification indicates storing pieces of structured parts list information related to "both previously designed electronic circuit boards and known electronic circuit boards". In those portions of the specification it is also indicated that the parts information includes parts incorporated into the electronic circuit boards.

From such disclosures one of ordinary skill in the art would clearly have understood that the reference to "different assemblies" corresponds to such electronic circuit boards.

Moreover, the claims are amended by the present response to now even further recite "each assembly corresponding to an electronic circuit board".

In view of these foregoing comments, applicants respectfully submit the claims are proper under 35 U.S.C. § 112, first paragraph.

¹ See specifically the specification at page 12, lines 2-3.

Addressing the above-noted prior art rejections, those rejections are traversed by the present response.

As noted above, each of the independent claims is amended by the present response to clarify features recited therein. Specifically, the independent claims now clarify the assembly information storage configured to store assembly information for a plurality of assemblies, "each assembly corresponding to an electronic circuit board".

The claims recite an assembly information storage storing information about a plurality of assemblies of plural parts, now clarified in the claims as electronic circuit boards, and information of parts included in the assemblies of electronic circuit boards, including names of the parts utilized in the assemblies.

Further, a parts information storage stores parts information including functions of the parts. In the claimed invention, information about the names, etc. of parts constituting an assembly of an electronic circuit board is obtained on the basis of input information identifying the electronic circuit board. Then, information about the functions, etc. of the parts forming the electronic circuit board is obtained based on the information about the names, etc. of the parts.

Further, parts information obtained corresponding to information of parts on the electronics circuit board can be replaced with information about other parts, having comparable functions. Thereby, replaced parts information can be generated and then stored. The features as discussed above are now clarified in the claims and are believed to clearly distinguish over the applied art.

As shown for example in Figures 1 and 4 in the present specification, a Resource database DB1 can store assembly information of parts in an electronic circuit board assembly and names of the parts. A parts information storage, such as Approved Parts DB in Figure 1, can store information including functions of parts corresponding to the parts information.

Further, the resource parts list creating/editing unit 3 can retrieve parts information from the Resource DB1 and Approved Parts DB2 and can replace the parts information corresponding with the assembly information with other parts information, for example for other parts having a comparable function as parts in the retrieved electronic circuit board assembly, and can store that replaced parts information in a memory.

The features recited in the claims are believed to clearly distinguish over the applied art.

<u>Tamaki</u> is directed to a production system that can access a parts list storage section 2 for storing parts list information and a parts stock storage section 4 for indicating a stock of parts. <u>Tamaki</u> goes on to note the use of a data storage unit 10, a superfluous parts adjusting unit 112, and a deficient parts adjusting unit 111. However, such teachings in <u>Tamaki</u> merely disclose an operation that can ensure that desired parts are in stock.

<u>Tamaki</u> is not at all directed to a system for creating and/or editing structured parts list information. Instead <u>Tamaki</u> is directed to a manufacturing system that can ensure that a list of required parts is adequately stocked, and determine whether any parts are deficient or superfluous. Such a structure in <u>Tamaki</u> differs from the claims as currently written.

<u>Tamaki</u> discloses a parts list storage section 2, but <u>Tamaki</u> does not disclose or suggest that storage element 2 stores information of a plurality of different electronic circuit board assemblies including parts, and information of a name of the parts, rather than just individual parts.

<u>Tamaki</u> also discloses a parts-in stock storage section 4 that is merely a listing of parts in storage and has no relation to the claimed features.

<u>Tamaki</u> also clearly fails to teach or suggest the "parts information retrieving device" or "assembly information update device" recited in the claims.

According to the claimed features, different parts information is retrieved. The first piece of information that is retrieved is assembly information. For example, the assembly information storage can store information directed to previously designed electronic circuit boards and known electronic circuit boards.² The second piece of information retrieved is parts attribute information. For example such information can include information of parts such as a parts identification, function, name and manufacture, shape, prospect, price, and/or approval data, and as recited in the claims includes *function* information of other components, which is comparable with a function of a part presently retrieved.³ Based on those two pieces of information replaced parts information is generated. Such features are clearly not met by <u>Tamaki</u>.

With respect to the above-noted features the outstanding Office Action notes that it would have been obvious that the "required parts" list of <u>Tamaki</u> would include a function of such parts. The Office Action specifically states:

...it would have been obvious to a person of ordinary skill in the art at the time of the invention that a list of "required parts" would include the function of such parts because a "required part" would be identified by its use or function in the product.⁴

Applicants traverse the above-noted basis for the rejection as it is simply not taught or suggested in <u>Tamaki</u>, and no apparent reason has been given to modify <u>Tamaki</u> to meet the claim limitations.

First, <u>Tamaki</u> clearly does not disclose or suggest storing information of a *function* of a part. Also, in <u>Tamaki</u> a list of required parts would *not* include such a function and a part would *not* be identified by its use or function. <u>Tamaki</u> merely discloses the parts list storage section 2 providing a *list of required parts*. A list of required parts would *not* include its part's function. In fact, storing information of a function of a part is actually contrary to the

² See for example the present specification at page 11, line 25 to page 12, line 6.

³ See for example the present specification at page 13, lines 1-11.

⁴ Office Action of March 29, 2007, page 18, first full paragraph.

operation of the device of <u>Tamaki</u>, and would actually be taught away from by the device of Tamaki.

That is, <u>Tamaki</u> is not at all concerned about indicating a *function* of a part as such information is *irrelevant* in Tamaki.

The claims recite storing information of a function of a part because in the claims one part can be substituted for another part with a comparable function. <u>Tamaki</u> does not disclose any reason or objective for storing information of a function of a part.

In the claimed features an assembly information storage stores information directed to a plurality of assemblies of electronic circuit boards, the assembly information including a name of parts utilized in the assembly. As an example noted above information directed to previously designed electronic circuit boards and known electronic circuit boards can be stored. The information of those circuit boards include names of the parts therein. Then, in the claimed invention parts information corresponding to the parts of the electronic circuit board assembly is output. Thus, in the claimed invention parts information for the parts that form the electronic circuit board component are then output, by the claimed "parts information storage". Tamaki does not disclose any similar feature.

In <u>Tamaki</u> the parts list storage section 2 is merely a parts list storage section and does not store information of a plurality of assemblies of electronic circuit boards, the assembly information including a name of parts utilized in the assembly. Further, the parts stock storage section 4 in <u>Tamaki</u> merely indicates a stock of parts. In <u>Tamaki</u> if a part is not stocked, no information of that part would appear to be provided. Thus, <u>Tamaki</u> clearly does not output parts attribute information including functions of parts corresponding to said parts information, as required in the claims.

Moreover, even if such elements in <u>Tamaki</u> correspond to the claimed features, which applicants dispute, <u>Tamaki</u> does not disclose or suggest creating replaced parts information

based on information in the parts list storage section 2 and information the parts stock storage section 4.

In such ways, the claims as currently written clearly distinguish over <u>Tamaki</u>.

Further, with respect to the further rejection based on <u>Tamaki</u> in view of <u>Tegethoff</u>, that rejection is traversed by the present response.

<u>Tegethoff</u> is directed to a method for manufacturing test simulation in electronic circuit design and relates to a tradeoff between productivity and design property.

The device disclosed by <u>Tegethoff</u> has no relation whatsoever to the device of <u>Tamaki</u>. <u>Tamaki</u> as noted above is directed to a system to ensure that parts are adequately stocked. <u>Tegethoff</u> is not directed to any type of such system and thus has no relevance whatsoever to the teachings in <u>Tamaki</u>.

The apparent reason set forth in the Office Action to combine the teachings in Tegethoff relative to those of Tamaki is also traversed. More specifically, the Office Action states the teachings of prediction concerning operation, simulation, etc. in Tegethoff could be applied to the teachings in Tamaki "because early prediction of manufacturing behavior drives design changes which optimize the product's manufacturability and testability, thus improving product quality and reducing cost and utilizing a parts list would help facilitate this prediction. See column 6 of Tegethoff". 5

The above-noted basis for the outstanding rejection is believed to be clearly improper as <u>Tamaki</u> is not directed to a device that would have any benefit from "driving design changes". <u>Tamaki</u> is clearly directed to a device utilized well *after any* type of design is implemented as <u>Tamaki</u> is directed to a device to ensure that parts are adequately stocked; which clearly takes place well *after any* design is implemented. The test simulation in electronic circuit design in <u>Tegethoff</u> has no relevance whatsoever to such a system as in

⁵ Office Action of March 29, 2007, top of page 20.

<u>Tamaki</u>. Further, what the basis for the outstanding rejection has not even considered or addressed is why the noted teachings in <u>Tegethoff</u> would be relative to <u>Tamaki</u> as <u>Tamaki</u> is not directed to any "prediction concerning operation, simulation, etc.".

In addressing the above-noted comments as to why one of ordinary skill in the art would not combine the teachings of <u>Tamaki</u> and <u>Tegethoff</u>, the outstanding Office Action recognizes that for a proper combination of teachings the prior art reference must either be in the field of applicants' endeavor or, if not, then be reasonably pertinent to the particular problem with which the applicants was concerned, in order to be relied upon as a basis for a rejection of the claimed invention.⁶

Applicants submit <u>Tamaki</u> and <u>Tegethoff</u> are not in the same field of endeavor and are not directed to solving a same problem.

In addressing the above-noted position that <u>Tamaki</u> and <u>Tegethoff</u> are not in the same field of endeavor, the outstanding Office Action on page 19 provides an explanation of the operation of the device of <u>Tegethoff</u>, emphasizing that <u>Tegethoff</u> is directed to a method for manufacturing test simulation in electronic circuit design. Applicants agree with that statement. However, as discussed above in detail a method for manufacturing test simulation in electronic design as in <u>Tegethoff</u> is completely *irrelevant* to the system of <u>Tamaki</u> which is directed to a production planning system for actually manufacturing different products.

Again as discussed above, <u>Tamaki</u> is clearly directed to a device utilized only after a design is implemented. <u>Tegethoff</u> is directed to a design process.

One of ordinary skill in the art could not have combined the teachings of <u>Tegethoff</u> to those of <u>Tamaki</u> since <u>Tamaki</u> is not directed to a design process. Teachings of a design process as in <u>Tegethoff</u> are completely irrelevant to <u>Tamaki</u>.

⁶ Office Action of March 29, 2007, bottom of page 18.

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Moreover, the outstanding rejection merely repeats Tegethoff allowing early prediction of manufacturing behavior drive design changes. However, the outstanding rejection still has not addressed why one of ordinary skill in the art would simulate electronic circuit design such as taught by Tegethoff in the system of Tamaki that ensures the parts are adequately stocked.

In such ways, applicants respectfully submit the further combination of teachings of Tamaki in view of Tegethoff is traversed by the present response.

In view of the foregoing comments applicants respectfully submit the claims as currently written clearly distinguish over the applied art.

As no other issues are pending in this application, it is respectfully submitted that the present application is now in condition for allowance, and it is hereby respectfully requested that this case be passed to issue.

Respectfully submitted,

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(OSMMN 06/04)

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